# **Switching Diode**

# BAS16L

#### **Features**

- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

# **MAXIMUM RATINGS**

| Rating   | Symbol                  | Value                                    | Unit |
|--|-------------------------|--|------|
| Continuous Reverse Voltage   | V <sub>R</sub>          | 100                                      | V    |
| Peak Forward Current   | IF                      | 200                                      | mA   |
| Non-Repetitive Peak Forward Surge<br>Current 60 Hz   | I <sub>FSM(surge)</sub> | 1.8                                      | Α    |
| Repetitive Peak Forward Current (Note 3)   | I <sub>FRM</sub>        | 1.0                                      | Α    |
| Non–Repetitive Peak Forward Current (Square Wave, $T_J = 25^{\circ}C$ prior to surge) $t = 1 \ \mu s$ $t = 10 \ \mu s$ $t = 100 \ \mu s$ $t = 1 \ ms$ $t = 10 \ ms$ $t = 100 \ ms$ $t = 1 \ s$ | IFSM                    | 36.0<br>18.0<br>6.0<br>3.0<br>1.8<br>1.3 | A    |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### THERMAL CHARACTERISTICS

| Characteristic   | Symbol                            | Max         | Unit        |
|--|-----------------------------------|-------------|-------------|
| Total Device Dissipation FR-5 Board<br>(Note 1)<br>T <sub>A</sub> = 25°C                     | P <sub>D</sub>                    | 225         | mW          |
| Derate above 25°C  |                                   | 1.8         | mW/°C       |
| Thermal Resistance, Junction-to-Ambient  | $R_{	heta JA}$                    | 556         | °C/W        |
| Total Device Dissipation Alumina Substrate, (Note 2) T <sub>A</sub> = 25°C Derate above 25°C | P <sub>D</sub>                    | 300<br>2.4  | mW<br>mW/°C |
| Thermal Resistance,<br>Junction-to-Ambient   | $R_{	heta JA}$                    | 417         | °C/W        |
| Junction and Storage Temperature   | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150 | °C          |

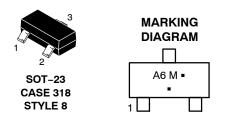
- 1. FR-5 = 1.0  $\times$  0.75  $\times$  0.062 in.
- 2. Alumina = 0.4  $\times$  0.3  $\times$  0.024 in. 99.5% alumina.
- 3. Square Wave, f = 40 kHz, PW = 200 ns Test Duration = 60 s,  $T_J$  = 25°C prior to surge.



# ON Semiconductor®

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A6 = Specific Device Code

M = Date Code\*

■ = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

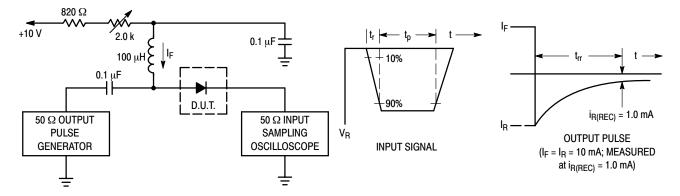
| Device     | Package             | Shipping <sup>†</sup> |
|------------|---------------------|-----------------------|
| BAS16LT1G  | SOT-23<br>(Pb-Free) | 3000/Tape & Reel      |
| BAS16LT3G  | SOT-23<br>(Pb-Free) | 10000/Tape & Reel     |
| SBAS16LT1G | SOT-23<br>(Pb-Free) | 3000/Tape & Reel      |
| SBAS16LT3G | SOT-23<br>(Pb-Free) | 10000/Tape & Reel     |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

| Characteristic  | Symbol            | Min              | Max                        | Unit |  |  |  |
|---|-------------------|------------------|----------------------------|------|--|--|--|
| OFF CHARACTERISTICS   |                   |                  |                            |      |  |  |  |
| Reverse Voltage Leakage Current $(V_R = 100 \text{ V})$ $(V_R = 75 \text{ Vdc}, T_J = 150^{\circ}\text{C})$ $(V_R = 25 \text{ Vdc}, T_J = 150^{\circ}\text{C})$ | I <sub>R</sub>    | -<br>-<br>-      | 1.0<br>50<br>30            | μAdc |  |  |  |
| Reverse Breakdown Voltage<br>(I <sub>BR</sub> = 100 μAdc)   | V <sub>(BR)</sub> | 100              | -                          | Vdc  |  |  |  |
| Forward Voltage $(I_F = 1.0 \text{ mAdc})$ $(I_F = 10 \text{ mAdc})$ $(I_F = 50 \text{ mAdc})$ $(I_F = 150 \text{ mAdc})$                                       | V <sub>F</sub>    | -<br>-<br>-<br>- | 715<br>855<br>1000<br>1250 | mV   |  |  |  |
| Diode Capacitance<br>(V <sub>R</sub> = 0, f = 1.0 MHz)  | C <sub>D</sub>    | -                | 2.0                        | pF   |  |  |  |
| Forward Recovery Voltage<br>(I <sub>F</sub> = 10 mAdc, t <sub>r</sub> = 20 ns)  | V <sub>FR</sub>   | -                | 1.75                       | Vdc  |  |  |  |
| Reverse Recovery Time $(I_F = I_R = 10 \text{ mAdc}, R_L = 50 \Omega)$  | t <sub>rr</sub>   | -                | 6.0                        | ns   |  |  |  |
| Stored Charge (I <sub>F</sub> = 10 mAdc to $V_R$ = 5.0 Vdc, $R_L$ = 500 $\Omega$ )  | Qs                | -                | 45                         | pC   |  |  |  |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



Notes: 1. A 2.0 k $\Omega$  variable resistor adjusted for a Forward Current (I<sub>F</sub>) of 10 mA.

- 2. Input pulse is adjusted so  $I_{R(peak)}$  is equal to 10 mA.
- 3. t<sub>p</sub> » t<sub>rr</sub>

Figure 1. Recovery Time Equivalent Test Circuit

# BAS16L

# **TYPICAL CHARACTERISTICS**

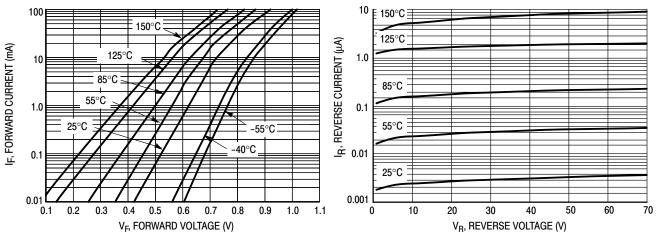


Figure 2. V<sub>F</sub> vs. I<sub>F</sub>

Figure 3. I<sub>R</sub> vs. V<sub>R</sub>

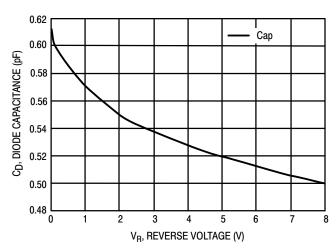


Figure 4. Capacitance

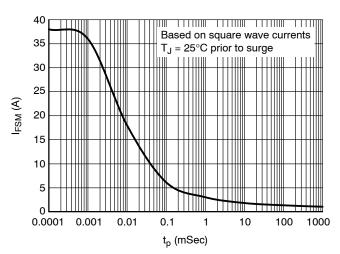


Figure 5. Maximum Non-repetitive Peak Forward Current as a Function of Pulse Duration, Typical Values



SOT-23 (TO-236) CASE 318-08 **ISSUE AS** 

**DATE 30 JAN 2018** 

# SCALE 4:1 D - 3X b

**TOP VIEW** 







#### **RECOMMENDED SOLDERING FOOTPRINT**



DIMENSIONS: MILLIMETERS

#### NOTES:

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
  MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH,

|  | PROT | RUSIONS, OR GATE BURRS. |  |
|--|------|-------------------------|--|
|--|------|-------------------------|--|

|     | MILLIMETERS |      |      | INCHES |       |       |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN         | NOM  | MAX  | MIN    | NOM   | MAX   |
| Α   | 0.89        | 1.00 | 1.11 | 0.035  | 0.039 | 0.044 |
| A1  | 0.01        | 0.06 | 0.10 | 0.000  | 0.002 | 0.004 |
| b   | 0.37        | 0.44 | 0.50 | 0.015  | 0.017 | 0.020 |
| С   | 0.08        | 0.14 | 0.20 | 0.003  | 0.006 | 0.008 |
| D   | 2.80        | 2.90 | 3.04 | 0.110  | 0.114 | 0.120 |
| E   | 1.20        | 1.30 | 1.40 | 0.047  | 0.051 | 0.055 |
| е   | 1.78        | 1.90 | 2.04 | 0.070  | 0.075 | 0.080 |
| L   | 0.30        | 0.43 | 0.55 | 0.012  | 0.017 | 0.022 |
| L1  | 0.35        | 0.54 | 0.69 | 0.014  | 0.021 | 0.027 |
| HE  | 2.10        | 2.40 | 2.64 | 0.083  | 0.094 | 0.104 |
| Т   | 0°          |      | 10°  | 0°     |       | 10°   |

## **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Date Code

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

| STYLE 1 THRU 5:<br>CANCELLED | STYLE 6:<br>PIN 1. BASE<br>2. EMITTER<br>3. COLLECTOR | STYLE 7:<br>PIN 1. EMITTER<br>2. BASE<br>3. COLLECTOR | STYLE 8:<br>PIN 1. ANODE<br>2. NO CONNECTION<br>3. CATHODE |
|------------------------------|---|---|--|
| OT (1 F O                    |   |   |  |

SOT-23 (TO-236)

| STYLE 9:                  | STYLE 10:                | STYLE 11:                       | STYLE 12:                 | STYLE 13:     | STYLE 14:               |
|---------------------------|--------------------------|---------------------------------|---------------------------|---------------|-------------------------|
| PIN 1. ANODE              | PIN 1. DRAIN             | PIN 1. ANODE                    | PIN 1. CATHODE            | PIN 1. SOURCE | PIN 1. CATHODE          |
| <ol><li>ANODE</li></ol>   | <ol><li>SOURCE</li></ol> | <ol><li>CATHODE</li></ol>       | <ol><li>CATHODE</li></ol> | 2. DRAIN      | 2. GATE                 |
| <ol><li>CATHODE</li></ol> | 3. GATE                  | <ol><li>CATHODE-ANODE</li></ol> | <ol><li>ANODE</li></ol>   | 3. GATE       | <ol><li>ANODE</li></ol> |

| STYLE 15:                 | STYLE 16:                 | STYLE 17:                 | STYLE 18:                 | STYLE 19:                      | STYLE 20:               |
|---------------------------|---------------------------|---------------------------|---------------------------|--------------------------------|-------------------------|
| PIN 1. GATE               | PIN 1. ANODE              | PIN 1. NO CONNECTION      | PIN 1. NO CONNECTION      | PIN 1. CATHODE                 | PIN 1. CATHODE          |
| <ol><li>CATHODE</li></ol> | <ol><li>CATHODE</li></ol> | 2. ANODE                  | <ol><li>CATHODE</li></ol> | 2. ANODE                       | <ol><li>ANODE</li></ol> |
| <ol><li>ANODE</li></ol>   | <ol><li>CATHODE</li></ol> | <ol><li>CATHODE</li></ol> | <ol><li>ANODE</li></ol>   | <ol><li>CATHODE-ANOD</li></ol> | E 3. GATE               |

| STYLE 21:                | STYLE 22:                | STYLE 23:    | STYLE 24:   | STYLE 25:    | STYLE 26:                       |
|--------------------------|--------------------------|--------------|-------------|--------------|---------------------------------|
| PIN 1. GATE              | PIN 1. RETURN            | PIN 1. ANODE | PIN 1. GATE | PIN 1. ANODE | PIN 1. CATHODE                  |
| <ol><li>SOURCE</li></ol> | <ol><li>OUTPUT</li></ol> | 2. ANODE     | 2. DRAIN    | 2. CATHODE   | 2. ANODE                        |
| 3 DRAIN                  | 3 INPLIT                 | 3 CATHODE    | 3. SOURCE   | 3. GATE      | <ol><li>NO CONNECTION</li></ol> |

| STYLE 27:<br>PIN 1. CATHODE<br>2. CATHODE<br>3. CATHODE | STYLE 28:<br>PIN 1. ANODE<br>2. ANODE<br>3. ANODE |  |
|---|---|--|
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